



YJG4D4G04A

N-Channel Enhancement Mode Field Effect Transistor

Product Summary

V_{DS}	40V
I_D	80A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	4.4m
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	8m
100% EAS Tested	
100% V_{DS} Tested	

General Description

Excellent package for heat dissipation
 High density cell design for low $R_{DS(ON)}$
 Moisture Sensitivity Level 1
 Epoxy Meets UL 94 V-0 Flammability Rating
 Halogen Free

Applications

Power switching application
 Uninterruptible power supply
 DC-DC convertor

Limiting Values

Parameter		Symbol	Min	Max	Unit	
Drain-source Voltage		V_{DS}	-	40	V	
Gate-source Voltage		V_{GS}	-20	20	V	
Continuous Drain Current (Note 1,2)	Steady-State	I_D	$T_A=25$, $V_{GS}= 10V$	-	18	A
			$T_A=100$, $V_{GS}= 10V$	-	12.7	
Continuous Drain Current (Note 1,3)	Steady-State		$T_C=25$, $V_{GS}= 10V$, Chip limitation	-	80	
			$T_C =100$, $V_{GS}= 10V$	-	56	
Pulsed Drain Current	$T_C=25$, t 10 μ s	I_{DM}	-	320	A	
Avalanche energy (non-repetitive)		$V_G=10V, R_G=25$, L=0.5mH, IAS=15.5A	EAS	-	60	mJ
Total Power Dissipation (Note 1,2)	Steady-State	P_D	$T_A=25$	-	2.6	W
			$T_A=100$	-	1.3	
Total Power Dissipation (Note 1,3)	Steady-State		$T_C=25$	-	51	
		$T_C =100$	-	25		



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Electrical Characteristics ($T_J=25$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	40	-	-	V
		$V_{GS}=0V, I_D=10mA$	40	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=32V, V_{GS}=0V$	-	-	1	μA
		$V_{DS}=32V, V_{GS}=0V, T_J=125$	-	-	100	
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.2	1.7	2.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=40A$	-	3.3		m
		$V_{GS}=4.5V, I_D=20A$	-	5.8	8	m
Diode Forward Voltage	V_{SD}	$I_S=40A, V_{GS}=0V$	-	0.85	1.2	V

Gate resistance



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Typical Electrical and Thermal Characteristics Diagrams

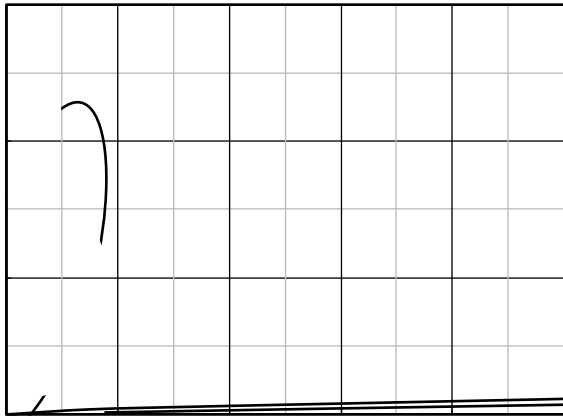


Figure 1. Output Characteristics

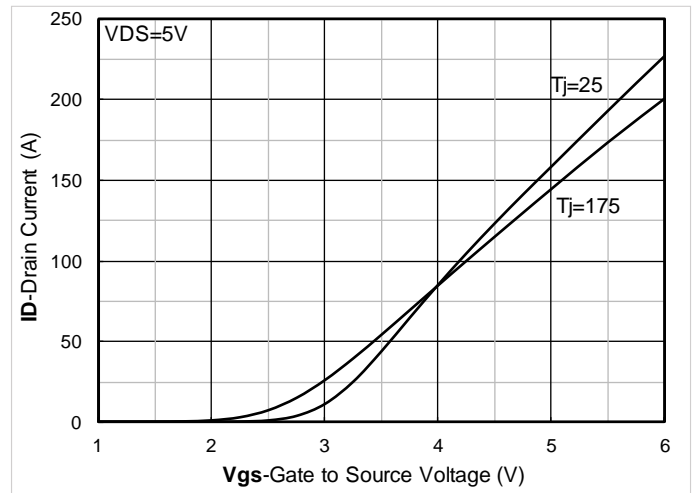


Figure 2. Transfer Characteristics

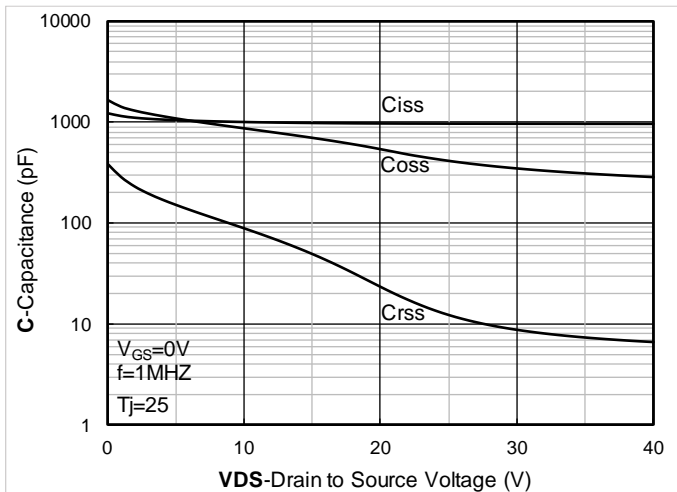


Figure 3. Capacitance Characteristics

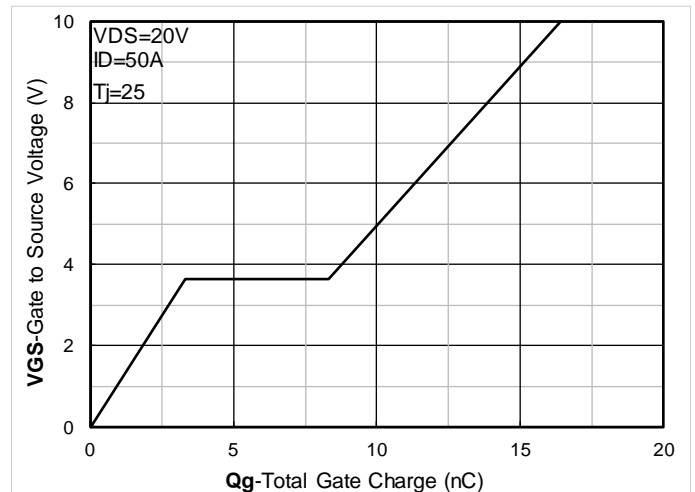


Figure 4. Gate Charge

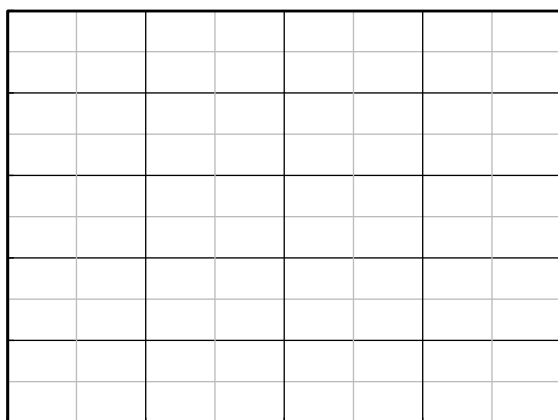
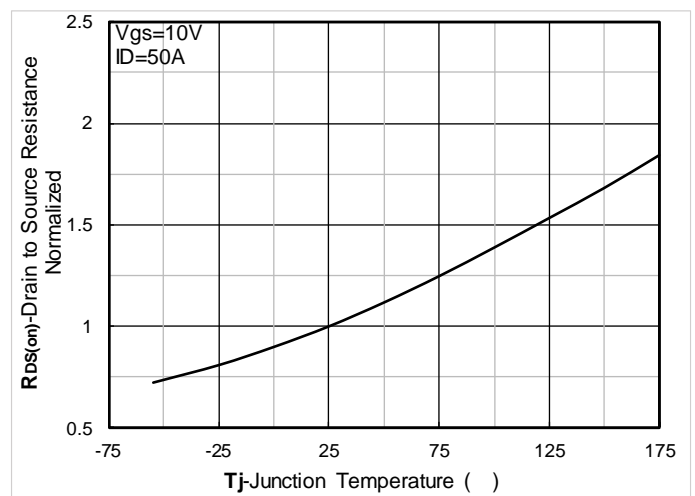


Figure 5. On-Resistance vs Gate to Source Voltage





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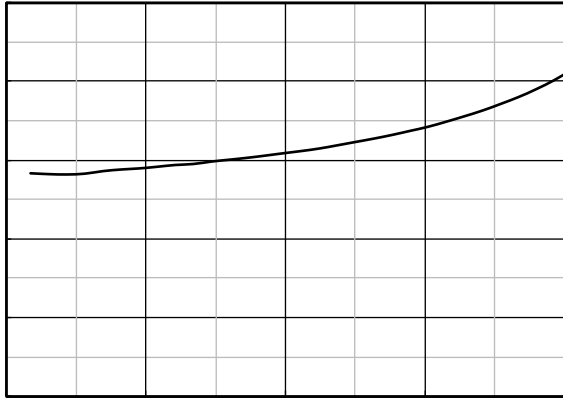


Figure 7. $R_{DS(on)}$ VS Drain Current

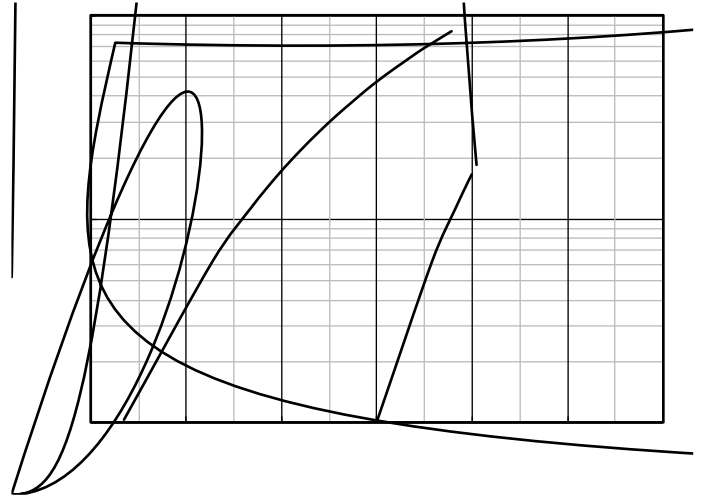


Figure 8. Forward characteristics of reverse diode

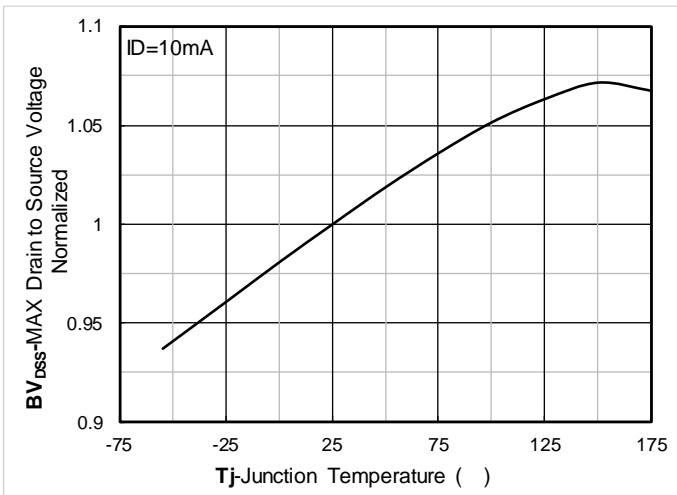


Figure 9. Normalized breakdown voltage

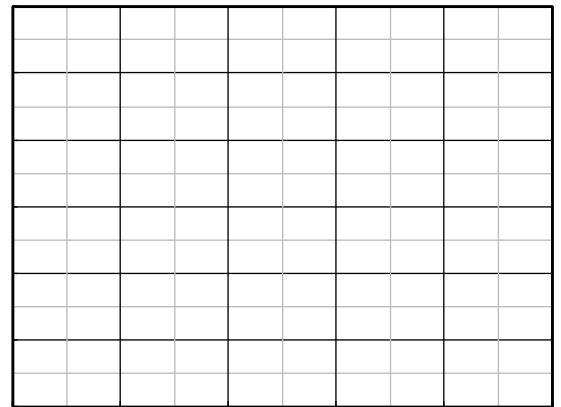
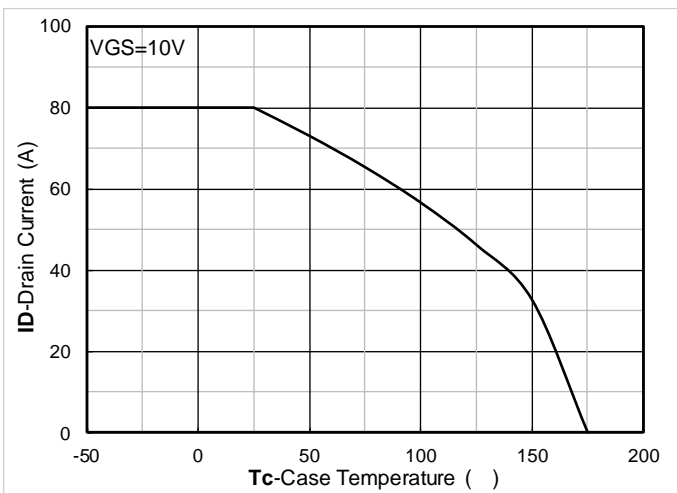


Figure 10. Normalized Threshold voltage





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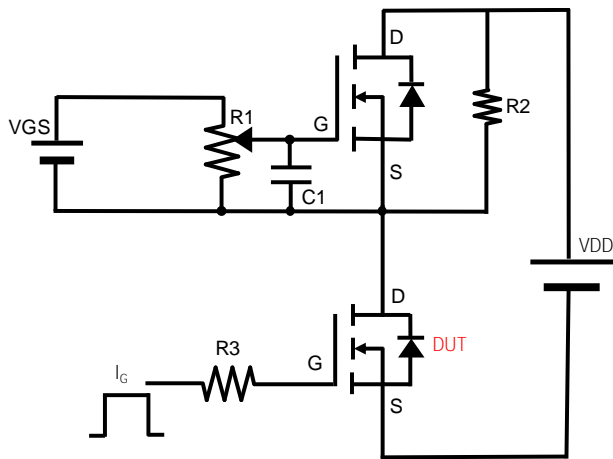


Figure B. Gate Charge Test Circuit & Waveform

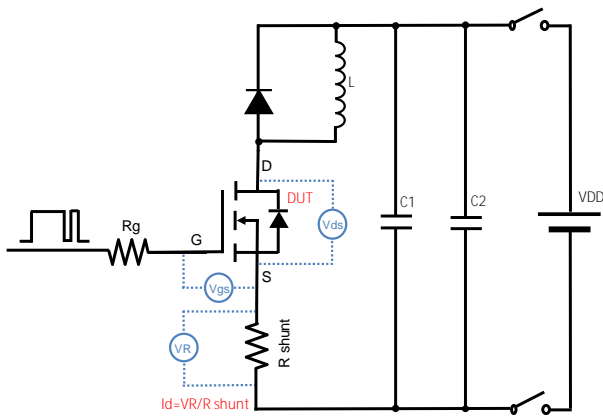


Figure C. Resistive Switching Test Circuit & Waveform

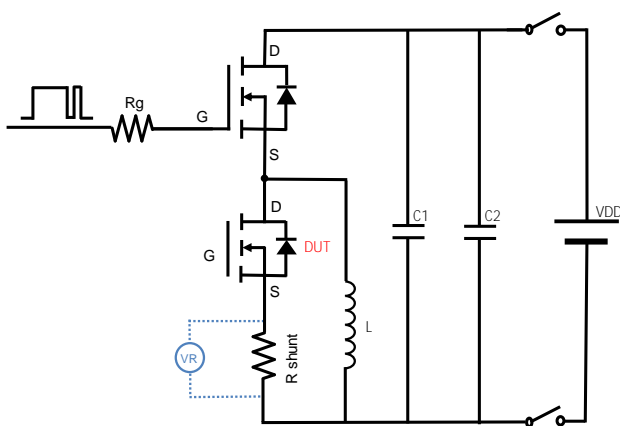


Figure D. Diode Recovery Test Circuit & Waveform

